



**THE DATASHEET OF  
SI5334M-B04824-GM**





# PIN-CONTROLLED ANY-FREQUENCY, ANY-OUTPUT QUAD CLOCK GENERATOR

### Features

- Low-power MultiSynth technology enables independent, any-frequency synthesis on four differential output drivers
- Highly-configurable output drivers support up to four differential outputs or eight single-ended clock outputs or a combination of both
- Low phase jitter: 0.7 ps RMS typ
- High-precision synthesis allows true 0 ppm frequency accuracy on all outputs
- Flexible input reference
  - External crystal: 8 to 30 MHz
  - CMOS input: 5 to 200 MHz
  - SSTL/HSTL input: 5 to 350 MHz
  - Differential input: 5 to 710 MHz
- Independently-configurable outputs support any frequency or format
  - LVPECL/LVDS: 0.16 to 710 MHz
  - HCSL: 0.16 to 250 MHz
  - CMOS: 0.16 to 200 MHz
  - SSTL/HSTL: 0.16 to 350 MHz
- Independent output voltage per driver
  - 1.5, 1.8, 2.5, or 3.3 V
- Independent core supply voltage
  - 1.8, 2.5, or 3.3 V
- Frequency increment/decrement feature enables glitchless frequency adjustments in 1 ppm steps
- Phase adjustment on each of the output drivers with <20 ps steps
- SSC on any or all outputs that is compliant to PCI Express
- Optional external feedback mode allows zero-delay implementation
- Loss-of-lock and loss-of-signal alarm
- Simple pin control
- Small size: 4x4 mm, 24-QFN
- Low power: 45 mA core supply typ
- Wide temperature range: -40 to +85 °C
- Contact Skyworks Solutions for custom versions



### Applications

- Ethernet switch/router
- PCI Express 2.0/3.0
- Broadcast video/audio timing
- Processor and FPGA clocking
- Any-frequency clock conversion
- MSAN/DSLAM/PON
- Fibre Channel, SAN
- Telecom line cards
- 1 GbE and 10 GbE

### Description

The Si5334 is a high performance, low jitter clock generator capable of synthesizing any frequency on each of the device's four differential output clocks. The device accepts an external reference clock or crystal and generates four differential clock outputs, each of which is independently configurable to any frequency up to 350 MHz and select frequencies to 710 MHz. Using Skyworks Solutions' patented MultiSynth technology, each output clock is generated with very low jitter and zero ppm frequency error. To provide additional design flexibility, each output clock is independently configurable to support any signal format and reference voltage. The Si5334 provides low jitter frequency synthesis with outstanding frequency flexibility in a space-saving 4 x 4 mm QFN package. The device configuration is factory or field programmed and, upon power up, the device will begin operation in the predefined configuration without user intervention. The device supports operation from a 1.8, 2.5, or 3.3 V core supply.



## Functional Block Diagram



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## 1. Electrical Specifications

**Table 1. Recommended Operating Conditions**

( $V_{DD} = 1.8\text{ V} -5\%$  to  $+10\%$ ,  $2.5\text{ V} \pm 10\%$ , or  $3.3\text{ V} \pm 10\%$ ,  $T_A = -40$  to  $85\text{ }^\circ\text{C}$ )

| Parameter                    | Symbol     | Test Condition | Min  | Typ | Max  | Unit             |
|------------------------------|------------|----------------|------|-----|------|------------------|
| Ambient Temperature          | $T_A$      |                | -40  | 25  | 85   | $^\circ\text{C}$ |
| Core Supply Voltage          | $V_{DD}$   |                | 2.97 | 3.3 | 3.63 | V                |
|                              |            |                | 2.25 | 2.5 | 2.75 | V                |
|                              |            |                | 1.71 | 1.8 | 1.98 | V                |
| Output Buffer Supply Voltage | $V_{DDOn}$ |                | 1.4  | —   | 3.63 | V                |

**Note:** All minimum and maximum specifications are guaranteed and apply across the recommended operating conditions. Typical values apply at nominal supply voltages and an operating temperature of  $25\text{ }^\circ\text{C}$  unless otherwise noted.

**Table 2. DC Characteristics**

( $V_{DD} = 1.8\text{ V} -5\%$  to  $+10\%$ ,  $2.5\text{ V} \pm 10\%$ , or  $3.3\text{ V} \pm 10\%$ ,  $T_A = -40$  to  $85\text{ }^\circ\text{C}$ )

| Parameter                         | Symbol     | Test Condition                                  | Min | Typ | Max | Unit |
|-----------------------------------|------------|---|-----|-----|-----|------|
| Core Supply Current               | $I_{DD}$   | 100 MHz on all outputs,<br>25 MHz refclk        | —   | 45  | 60  | mA   |
| Core Supply Current (Buffer Mode) | $I_{DDB}$  | 50 MHz refclk                                   | —   | 12  | —   | mA   |
| Output Buffer Supply Current      | $I_{DDOx}$ | LVPECL, 710 MHz                                 | —   | —   | 30  | mA   |
|                                   |            | LVDS, 710 MHz                                   | —   | —   | 8   | mA   |
|                                   |            | HCSL, 250 MHz<br>2 pF load                      | —   | —   | 20  | mA   |
|                                   |            | CML, 350 MHz                                    | —   | 12  | —   | mA   |
|                                   |            | SSTL, 350 MHz                                   | —   | —   | 19  | mA   |
|                                   |            | CMOS, 50 MHz<br>15 pF load <sup>1</sup>         | —   | 6   | 9   | mA   |
|                                   |            | CMOS, 200 MHz <sup>1,2</sup><br>3.3 V $V_{DD0}$ | —   | 13  | 18  | mA   |
|                                   |            | CMOS, 200 MHz <sup>1,2</sup><br>2.5 V           | —   | 10  | 14  | mA   |
|                                   |            | CMOS, 200 MHz <sup>1,2</sup><br>1.8 V           | —   | 7   | 10  | mA   |
|                                   |            | HSTL, 350 MHz                                   | —   | —   | 19  | mA   |

**Notes:**

- Single CMOS driver active.
- Measured into a  $5''\ 50\ \Omega$  trace with 2 pF load.

**Table 3. Performance Characteristics**(V<sub>DD</sub> = 1.8 V -5% to +10%, 2.5 V ±10%, or 3.3 V ±10%, T<sub>A</sub> = -40 to 85 °C)

| Parameter                                     | Symbol              | Test Condition                  | Min  | Typ    | Max                   | Unit |
|---|---------------------|---------------------------------|------|--------|-----------------------|------|
| PLL Acquisition Time                          | t <sub>ACQ</sub>    |                                 | —    | —      | 25                    | ms   |
| PLL Tracking Range                            | f <sub>TRACK</sub>  |                                 | 5000 | 20,000 | —                     | ppm  |
| PLL Loop Bandwidth                            | f <sub>BW</sub>     |                                 | —    | 1.6    | —                     | MHz  |
| MultiSynth Frequency Synthesis Resolution     | f <sub>RES</sub>    | Output frequency ≤ Fvco/8       | 0    | 0      | 1                     | ppb  |
| CLKIN Loss of Signal Assert Time              | t <sub>LOS</sub>    |                                 | —    | 2.6    | 5                     | μs   |
| CLKIN Loss of Signal Deassert Time            | t <sub>LOS_b</sub>  |                                 | 0.01 | 0.2    | 1                     | μs   |
| PLL Loss of Lock Detect Time                  | t <sub>LOL</sub>    |                                 | —    | 5      | 10                    | ms   |
| POR to Output Clock Valid                     | t <sub>RDY</sub>    |                                 | —    | —      | 2                     | ms   |
| Input-to-Output Propagation Delay             | t <sub>PROP</sub>   | Buffer Mode (PLL Bypass)        | —    | 2.5    | 4                     | ns   |
| Output-Output Skew                            | t <sub>DSKEW</sub>  | Rn divider = 1 <sup>1</sup>     | —    | —      | 100                   | ps   |
| Programmable Initial Phase Offset             | P <sub>OFFSET</sub> |                                 | -45  | —      | +45                   | ns   |
| Phase Increment/Decrement Accuracy            | P <sub>STEP</sub>   |                                 | —    | —      | 20                    | ps   |
| Phase Increment/Decrement Range               | P <sub>RANGE</sub>  |                                 | -45  | —      | +45                   | ns   |
| Frequency range for phase increment/decrement | f <sub>PRANGE</sub> |                                 | —    | —      | 350 <sup>2</sup>      | MHz  |
| Phase Increment/Decrement Update Rate         | P <sub>UPDATE</sub> | Pin control                     | —    | —      | 1500                  | kHz  |
| Frequency Increment/Decrement Step Size       | f <sub>STEP</sub>   | R divider not used <sup>3</sup> | 1    | —      | See Note <sup>3</sup> | ppm  |
| Frequency Increment/Decrement Range           | f <sub>RANGE</sub>  | R divider not used <sup>3</sup> | —    | —      | 350 <sup>2</sup>      | MHz  |
| Frequency Increment/Decrement Update Rate     | f <sub>UPDATE</sub> | Pin control <sup>2,3</sup>      | —    | —      | 1500                  | kHz  |

**Notes:**

1. Outputs at integer-related frequencies and using the same driver format.
2. Keep MultiSynth output frequency between 5 MHz to Fvco/8.
3. Only MultiSynth0 can have frequency inc/dec but MultiSynth0 can be routed to any output.
4. Spread spectrum is only available on clock outputs that are at 100 MHz and have the Rn divider set to 1.

**Table 3. Performance Characteristics (Continued)**

( $V_{DD} = 1.8\text{ V} -5\%$  to  $+10\%$ ,  $2.5\text{ V} \pm 10\%$ , or  $3.3\text{ V} \pm 10\%$ ,  $T_A = -40$  to  $85\text{ }^\circ\text{C}$ )

| Parameter                              | Symbol     | Test Condition                          | Min | Typ  | Max | Unit |
|--|------------|---|-----|------|-----|------|
| Spread Spectrum PP Frequency Deviation | $SS_{DEV}$ | Clock frequency of 100 MHz <sup>4</sup> | —   | -0.5 | —   | %    |
| Spread Spectrum Modulation Rate        | $SS_{DEV}$ | Clock frequency of 100 MHz              | 30  | —    | 33  | kHz  |

**Notes:**

1. Outputs at integer-related frequencies and using the same driver format.
2. Keep MultiSynth output frequency between 5 MHz to  $F_{vco}/8$ .
3. Only MultiSynth0 can have frequency inc/dec but MultiSynth0 can be routed to any output.
4. Spread spectrum is only available on clock outputs that are at 100 MHz and have the Rn divider set to 1.

**Table 4. Input and Output Clock Characteristics**

( $V_{DD} = 1.8\text{ V} -5\%$  to  $+10\%$ ,  $2.5\text{ V} \pm 10\%$ , or  $3.3\text{ V} \pm 10\%$ ,  $T_A = -40$  to  $85\text{ }^\circ\text{C}$ )

| Parameter   | Symbol    | Test Condition | Min  | Typ | Max             | Units      |
|---|-----------|----------------|------|-----|-----------------|------------|
| <b>Input Clock (AC Coupled Differential Input Clocks on Pins IN1/2, IN5/6)<sup>1</sup></b>  |           |                |      |     |                 |            |
| Frequency   | $f_{IN}$  |                | 5    | —   | 710             | MHz        |
| Differential Voltage Swing  | $V_{PP}$  | 710 MHz input  | 0.4  | —   | 2.4             | $V_{PP}$   |
| Rise/Fall Time <sup>2</sup>   | $t_R/t_F$ | 20%–80%        | —    | —   | 1.0             | ns         |
| Duty Cycle  | DC        | < 1 ns tr/ff   | 40   | —   | 60              | %          |
| Input Impedance <sup>1</sup>  | $R_{IN}$  |                | 10   | —   | —               | k $\Omega$ |
| Input Capacitance   | $C_{IN}$  |                | —    | 3.5 | —               | pF         |
| <b>Input Clock (DC-coupled Single-Ended Input Clock on Pins IN3/4)</b>  |           |                |      |     |                 |            |
| Frequency   | $f_{IN}$  | CMOS           | 5    | —   | 200             | MHz        |
| Input Voltage   | $V_I$     |                | -0.1 | —   | 3.73            | $V_{PP}$   |
| Input Voltage Swing   |           | 200 MHz        | 0.8  | —   | $V_{DD} + 10\%$ | $V_{PP}$   |
| Rise/Fall Time <sup>3</sup>   | $t_R/t_F$ | 10%–90%        | —    | —   | 4               | ns         |
| Rise/Fall Time <sup>3</sup>   | $t_R/t_F$ | 20%–80%        | —    | —   | 2.3             | ns         |
| Duty Cycle  | DC        | < 2 ns tr/ff   | 40   | —   | 60              | %          |
| Input Capacitance   | $C_{IN}$  |                | —    | 2.0 | —               | pF         |
| <b>Output Clocks (Differential)</b>   |           |                |      |     |                 |            |
| <b>Notes:</b>   |           |                |      |     |                 |            |
| <ol style="list-style-type: none"> <li>1. Use an external 100 <math>\Omega</math> resistor to provide load termination for a differential clock. See "2.2. Crystal/Clock Input" on page 15.</li> <li>2. For best jitter performance, keep the input slew rate on IN1/2, IN5/6 faster than 0.3 V/ns.</li> <li>3. For best jitter performance, keep the input single ended slew rate on pins 3 or 4 faster than 1 V/ns.</li> <li>4. Only two unique frequencies above <math>F_{vco}/8</math> can be simultaneously output, <math>F_{vco}/4</math> and <math>F_{vco}/6</math>.</li> <li>5. CML output format requires ac-coupling of the differential outputs to a differential 100 <math>\Omega</math> load at the receiver.</li> <li>6. Includes effect of internal series 22 <math>\Omega</math> resistor.</li> </ol> |           |                |      |     |                 |            |

**Table 4. Input and Output Clock Characteristics (Continued)** $(V_{DD} = 1.8\text{ V} -5\% \text{ to } +10\%, 2.5\text{ V} \pm 10\%, \text{ or } 3.3\text{ V} \pm 10\%, T_A = -40 \text{ to } 85\text{ }^\circ\text{C})$ 

| Parameter   | Symbol     | Test Condition                  | Min   | Typ                       | Max    | Units    |
|---|------------|---------------------------------|-------|---------------------------|--------|----------|
| Frequency <sup>4</sup>  | $f_{OUT}$  | LVPECL, LVDS                    | 0.16  | —                         | 350    | MHz      |
|   |            |                                 | 367   | —                         | 473.33 | MHz      |
|   |            |                                 | 550   | —                         | 710    | MHz      |
|   |            | HCSL                            | 0.16  | —                         | 250    | MHz      |
| LVPECL Output Voltage   | $V_{OC}$   | common mode                     | —     | $V_{DDO} - 1.45\text{ V}$ | —      | V        |
|   | $V_{SEPP}$ | peak-to-peak single-ended swing | 0.55  | 0.8                       | 0.96   | $V_{PP}$ |
| LVDS Output Voltage (2.5/3.3 V)   | $V_{OC}$   | common mode                     | 1.125 | 1.2                       | 1.275  | V        |
|   | $V_{SEPP}$ | peak-to-peak single-ended swing | 0.25  | 0.35                      | 0.45   | $V_{PP}$ |
| LVDS Output Voltage (1.8 V)   | $V_{OC}$   | common mode                     | 0.8   | 0.875                     | 0.95   | V        |
|   | $V_{SEPP}$ | peak-to-peak single-ended swing | 0.25  | 0.35                      | 0.45   | $V_{PP}$ |
| HCSL Output Voltage   | $V_{OC}$   | common mode                     | 0.35  | 0.375                     | 0.400  | V        |
|   | $V_{SEPP}$ | peak-to-peak single-ended swing | 0.575 | 0.725                     | 0.85   | $V_{PP}$ |
| CML Output Voltage  | $V_{OC}$   | Common Mode                     | —     | See Note <sup>5</sup>     | —      | V        |
|   | $V_{SEPP}$ | Peak-to-Peak Single-ended Swing | 0.67  | 0.860                     | 1.07   | $V_{PP}$ |
| Rise/Fall Time  | $t_R/t_F$  | 20%–80%                         | —     | —                         | 450    | ps       |
| Duty Cycle  | DC         |                                 | 45    | —                         | 55     | %        |
| <b>Output Clocks (Single-Ended)</b>   |            |                                 |       |                           |        |          |
| Frequency   | $f_{OUT}$  | CMOS                            | 0.16  | —                         | 200    | MHz      |
|   |            | SSTL, HSTL                      | 0.16  | —                         | 350    | MHz      |
| CMOS 20%–80% Rise/Fall Time   | $t_R/t_F$  | 2 pF load                       | —     | 0.45                      | 0.85   | ns       |
| CMOS 20%–80% Rise/Fall Time   | $t_R/t_F$  | 15 pF load                      | —     | —                         | 2.0    | ns       |
| <b>Notes:</b>   |            |                                 |       |                           |        |          |
| 1. Use an external 100 $\Omega$ resistor to provide load termination for a differential clock. See "2.2. Crystal/Clock Input" on page 15. |            |                                 |       |                           |        |          |
| 2. For best jitter performance, keep the input slew rate on IN1/2, IN5/6 faster than 0.3 V/ns.  |            |                                 |       |                           |        |          |
| 3. For best jitter performance, keep the input single ended slew rate on pins 3 or 4 faster than 1 V/ns.                                  |            |                                 |       |                           |        |          |
| 4. Only two unique frequencies above $F_{VCO}/8$ can be simultaneously output, $F_{VCO}/4$ and $F_{VCO}/6$ .                              |            |                                 |       |                           |        |          |
| 5. CML output format requires ac-coupling of the differential outputs to a differential 100 $\Omega$ load at the receiver.                |            |                                 |       |                           |        |          |
| 6. Includes effect of internal series 22 $\Omega$ resistor.   |            |                                 |       |                           |        |          |

**Table 4. Input and Output Clock Characteristics (Continued)**

( $V_{DD} = 1.8\text{ V} -5\%$  to  $+10\%$ ,  $2.5\text{ V} \pm 10\%$ , or  $3.3\text{ V} \pm 10\%$ ,  $T_A = -40$  to  $85\text{ }^\circ\text{C}$ )

| Parameter                        | Symbol   | Test Condition                                  | Min                          | Typ | Max                          | Units    |
|----------------------------------|----------|---|------------------------------|-----|------------------------------|----------|
| CMOS Output Resistance           |          | See Note <sup>6</sup>                           | —                            | 50  | —                            | $\Omega$ |
| SSTL Output Resistance           |          |   | —                            | 50  | —                            | $\Omega$ |
| HSTL Output Resistance           |          |   | —                            | 50  | —                            | $\Omega$ |
| CMOS Output Voltage <sup>6</sup> | $V_{OH}$ | 4 mA load                                       | $V_{DDO} - 0.3$              | —   |                              | V        |
|                                  | $V_{OL}$ | 4 mA load                                       |                              | —   | 0.3                          | V        |
| SSTL Output Voltage              | $V_{OH}$ | SSTL-3 $V_{DDOx} = 2.97$<br>to $3.63\text{ V}$  | $0.45 \times V_{DDO} + 0.41$ | —   | —                            | V        |
|                                  | $V_{OL}$ |   | —                            | —   | $0.45 \times V_{DDO} - 0.41$ | V        |
|                                  | $V_{OH}$ | SSTL-2 $V_{DDOx} = 2.25$<br>to $2.75\text{ V}$  | $0.5 \times V_{DDO} + 0.41$  | —   | —                            | V        |
|                                  | $V_{OL}$ |   | —                            | —   | $0.5 \times V_{DDO} - 0.41$  | V        |
|                                  | $V_{OH}$ | SSTL-18 $V_{DDOx} = 1.71$<br>to $1.98\text{ V}$ | $0.5 \times V_{DDO} + 0.34$  | —   | —                            | V        |
|                                  | $V_{OL}$ |   | —                            | —   | $0.5 \times V_{DDO} - 0.34$  | V        |
| HSTL Output Voltage              | $V_{OH}$ | $V_{DDO} = 1.4$ to $1.6\text{ V}$               | $0.5 \times V_{DDO} + 0.3$   | —   | —                            | V        |
|                                  | $V_{OL}$ |   | —                            | —   | $0.5 \times V_{DDO} - 0.3$   | V        |
| Duty Cycle                       | DC       |   | 45                           | —   | 55                           | %        |

**Notes:**

1. Use an external  $100\ \Omega$  resistor to provide load termination for a differential clock. See "2.2. Crystal/Clock Input" on page 15.
2. For best jitter performance, keep the input slew rate on IN1/2, IN5/6 faster than  $0.3\text{ V/ns}$ .
3. For best jitter performance, keep the input single ended slew rate on pins 3 or 4 faster than  $1\text{ V/ns}$ .
4. Only two unique frequencies above  $F_{vco}/8$  can be simultaneously output,  $F_{vco}/4$  and  $F_{vco}/6$ .
5. CML output format requires ac-coupling of the differential outputs to a differential  $100\ \Omega$  load at the receiver.
6. Includes effect of internal series  $22\ \Omega$  resistor.

**Table 5. Control Pins**(V<sub>DD</sub> = 1.8 V –5% to +10%, 2.5 V ±10%, or 3.3 V ±10%, T<sub>A</sub> = –40 to 85 °C)

| Parameter                            | Symbol                         | Condition                              | Min                   | Typ | Max                   | Unit |
|--------------------------------------|--------------------------------|--|-----------------------|-----|-----------------------|------|
| <b>Input Control Pins (IN3, IN4)</b> |                                |  |                       |     |                       |      |
| Input Voltage Low                    | V <sub>IL</sub>                |  | –0.1                  | —   | 0.3 x V <sub>DD</sub> | V    |
| Input Voltage High                   | V <sub>IH</sub>                |  | 0.7 x V <sub>DD</sub> | —   | 3.73                  | V    |
| Input Capacitance                    | C <sub>IN</sub>                |  | —                     | —   | 4                     | pF   |
| Input Resistance                     | R <sub>IN</sub>                |  | —                     | 20  | —                     | kΩ   |
| <b>Output Control Pins (LOSLOL)</b>  |                                |  |                       |     |                       |      |
| Output Voltage Low                   | V <sub>OL</sub>                | I <sub>SINK</sub> = 3 mA               | 0                     | —   | 0.4                   | V    |
| Rise/Fall Time<br>20–80%             | t <sub>R</sub> /t <sub>F</sub> | C <sub>L</sub> < 10 pf, pull up = 1 kΩ | —                     | —   | 10                    | ns   |

**Table 6. Crystal Specifications for 8 to 11 MHz**

| Parameter                               | Symbol                       | Min | Typ | Max | Unit |
|---|------------------------------|-----|-----|-----|------|
| Crystal Frequency                       | f <sub>XTAL</sub>            | 8   | —   | 11  | MHz  |
| Load Capacitance (on-chip differential) | c <sub>L</sub> (supported)*  | 11  | 12  | 13  | pF   |
|   | c <sub>L</sub> (recommended) | 17  | 18  | 19  | pF   |
| Crystal Output Capacitance              | c <sub>O</sub>               | —   | —   | 6   | pF   |
| Equivalent Series Resistance            | r <sub>ESR</sub>             | —   | —   | 300 | Ω    |
| Crystal Max Drive Level                 | d <sub>L</sub>               | 100 | —   | —   | μW   |

\*Note: See "AN360: Crystal Selection Guide for Si533x and Si5355/56 Devices" for more information.

**Table 7. Crystal Specifications for 11 to 19 MHz**

| Parameter                               | Symbol                       | Min | Typ | Max | Unit |
|---|------------------------------|-----|-----|-----|------|
| Crystal Frequency                       | f <sub>XTAL</sub>            | 11  | —   | 19  | MHz  |
| Load Capacitance (on-chip differential) | c <sub>L</sub> (supported)*  | 11  | 12  | 13  | pF   |
|   | c <sub>L</sub> (recommended) | 17  | 18  | 19  | pF   |
| Crystal Output Capacitance              | c <sub>O</sub>               | —   | —   | 5   | pF   |
| Equivalent Series Resistance            | r <sub>ESR</sub>             | —   | —   | 200 | Ω    |
| Crystal Max Drive Level                 | d <sub>L</sub>               | 100 | —   | —   | μW   |

\*Note: See "AN360: Crystal Selection Guide for Si533x and Si5355/56 Devices" for more information.

**Table 8. Crystal Specifications for 19 to 26 MHz**

| Parameter                               | Symbol              | Min | Typ | Max | Unit     |
|---|---------------------|-----|-----|-----|----------|
| Crystal Frequency                       | $f_{XTAL}$          | 19  |     | 26  | MHz      |
| Load Capacitance (on-chip differential) | $c_L$ (supported)*  | 11  | 12  | 13  | pF       |
|   | $c_L$ (recommended) | 17  | 18  | 19  | pF       |
| Crystal Output Capacitance              | $c_O$               |     |     | 5   | pF       |
| Equivalent Series Resistance            | $r_{ESR}$           |     |     | 100 | $\Omega$ |
| Crystal Max Drive Level                 | $d_L$               | 100 |     |     | $\mu W$  |

**\*Note:** See "AN360: Crystal Selection Guide for Si533x and Si5355/56 Devices" for more information.

**Table 9. Crystal Specifications for 26 to 30 MHz**

| Parameter                               | Symbol              | Min | Typ | Max | Unit     |
|---|---------------------|-----|-----|-----|----------|
| Crystal Frequency                       | $f_{XTAL}$          | 26  |     | 30  | MHz      |
| Load Capacitance (on-chip differential) | $c_L$ (supported)*  | 11  | 12  | 13  | pF       |
|   | $c_L$ (recommended) | 17  | 18  | 19  | pF       |
| Crystal Output Capacitance              | $c_O$               |     |     | 5   | pF       |
| Equivalent Series Resistance            | $r_{ESR}$           |     |     | 75  | $\Omega$ |
| Crystal Max Drive Level                 | $d_L$               | 100 |     |     | $\mu W$  |

**\*Note:** See "AN360: Crystal Selection Guide for Si533x and Si5355/56 Devices" for more information.

**Table 10. Jitter Specifications<sup>1,2,3</sup>**(V<sub>DD</sub> = 1.8 V -5% to +10%, 2.5 V ±10%, or 3.3 V ±10%, T<sub>A</sub> = -40 to 85 °C)

| Parameter   | Symbol            | Test Condition   | Min | Typ  | Max  | Unit               |
|---|-------------------|--|-----|------|------|--------------------|
| GbE Random Jitter<br>(12 kHz–20 MHz) <sup>4</sup> | J <sub>GbE</sub>  | CLKIN = 25 MHz<br>All CLK <sub>n</sub> at 125 MHz <sup>5</sup>                                   | —   | 0.7  | 1    | ps RMS             |
| GbE Random Jitter<br>(1.875–20 MHz)               | R <sub>JGbE</sub> | CLKIN = 25 MHz<br>All CLK <sub>n</sub> at 125 MHz <sup>5</sup>                                   | —   | 0.38 | 0.79 | ps RMS             |
| OC-12 Random Jitter<br>(12 kHz–5 MHz)             | J <sub>OC12</sub> | CLKIN = 19.44 MHz<br>All CLK <sub>n</sub> at<br>155.52 MHz <sup>5</sup>                          | —   | 0.7  | 1    | ps RMS             |
| PCI Express 1.1 Common<br>Clock                   |                   | Total Jitter <sup>6</sup>  | —   | 20.1 | 33.6 | ps pk-pk           |
| PCI Express 2.1 Common<br>Clock                   |                   | RMS Jitter <sup>6</sup> , 10 kHz to<br>1.5 MHz   | —   | 0.15 | 1.47 | ps RMS             |
|   |                   | RMS Jitter <sup>6</sup> , 1.5 MHz to<br>50 MHz   | —   | 0.58 | 0.75 | ps RMS             |
| PCI Express 3.0 Common<br>Clock                   |                   | RMS Jitter <sup>6</sup>  | —   | 0.15 | 0.45 | ps RMS             |
| Period Jitter                                     | J <sub>PER</sub>  | N = 10,000 cycles <sup>7</sup>   | —   | 10   | 30   | ps pk-pk           |
| Cycle-Cycle Jitter                                | J <sub>CC</sub>   | N = 10,000 cycles<br>Output MultiSynth<br>operated in integer or<br>fractional mode <sup>7</sup> | —   | 9    | 29   | ps pk <sup>8</sup> |
| Random Jitter<br>(12 kHz–20 MHz)                  | R <sub>J</sub>    | Output and feedback<br>MultiSynth in integer or<br>fractional mode <sup>7</sup>                  | —   | 0.7  | 1.5  | ps RMS             |

**Notes:**

- All jitter measurements apply for LVDS/HCSL/LVPECL output format with a low noise differential input clock and are made with an Agilent 90804 oscilloscope. All RJ measurements use RJ/DJ separation.
- For best jitter performance, keep the single ended clock input slew rates at Pins 3 and 4 more than 1.0 V/ns and the differential clock input slew rates more than 0.3 V/ns.
- All jitter data in this table is based upon all output formats being differential. When single-ended outputs are used, there is the potential that the output jitter may increase due to the nature of single-ended outputs. If your configuration implements any single-ended output and any output is required to have jitter less than 3 ps rms, contact Skyworks Solutions for support to validate your configuration and ensure the best jitter performance. In many configurations, CMOS outputs have little to no effect upon jitter.
- D<sub>J</sub> for PCI and GbE is < 5 ps pp
- Output MultiSynth in Integer mode.
- All output clocks 100 MHz HCSL format. Jitter is from the PCIe jitter filter combination that produces the highest jitter. See AN562 for details. Jitter is measured with the Intel Clock Jitter Tool, Ver.1.6.4.
- Input frequency to the Phase Detector between 25 and 40 MHz and any output frequency ≥ 5 MHz.
- Measured in accordance with JEDEC standard 65.
- R<sub>J</sub> is multiplied by 14; estimate the pp jitter from R<sub>J</sub> over 2<sup>12</sup> rising edges.

**Table 10. Jitter Specifications<sup>1,2,3</sup> (Continued)** $(V_{DD} = 1.8\text{ V} -5\% \text{ to } +10\%, 2.5\text{ V} \pm 10\%, \text{ or } 3.3\text{ V} \pm 10\%, T_A = -40 \text{ to } 85\text{ }^\circ\text{C})$ 

| Parameter                       | Symbol  | Test Condition   | Min | Typ | Max | Unit     |
|---------------------------------|---|--|-----|-----|-----|----------|
| Deterministic Jitter            | $D_J$   | Output MultiSynth operated in fractional mode <sup>7</sup> | —   | 3   | 15  | ps pk-pk |
|                                 |   | Output MultiSynth operated in integer mode <sup>7</sup>    | —   | 2   | 10  | ps pk-pk |
| Total Jitter<br>(12 kHz–20 MHz) | $T_J = D_J + 14 \times R_J$<br>(See Note <sup>9</sup> ) | Output MultiSynth operated in fractional mode <sup>7</sup> | —   | 13  | 36  | ps pk-pk |
|                                 |   | Output MultiSynth operated in integer mode <sup>7</sup>    | —   | 12  | 20  | ps pk-pk |

**Notes:**

- All jitter measurements apply for LVDS/HCSL/LVPECL output format with a low noise differential input clock and are made with an Agilent 90804 oscilloscope. All RJ measurements use RJ/DJ separation.
- For best jitter performance, keep the single ended clock input slew rates at Pins 3 and 4 more than 1.0 V/ns and the differential clock input slew rates more than 0.3 V/ns.
- All jitter data in this table is based upon all output formats being differential. When single-ended outputs are used, there is the potential that the output jitter may increase due to the nature of single-ended outputs. If your configuration implements any single-ended output and any output is required to have jitter less than 3 ps rms, contact Skyworks Solutions for support to validate your configuration and ensure the best jitter performance. In many configurations, CMOS outputs have little to no effect upon jitter.
- $D_J$  for PCI and GbE is < 5 ps pp
- Output MultiSynth in Integer mode.
- All output clocks 100 MHz HCSL format. Jitter is from the PCIe jitter filter combination that produces the highest jitter. See AN562 for details. Jitter is measured with the Intel Clock Jitter Tool, Ver.1.6.4.
- Input frequency to the Phase Detector between 25 and 40 MHz and any output frequency  $\geq 5$  MHz.
- Measured in accordance with JEDEC standard 65.
- $R_J$  is multiplied by 14; estimate the pp jitter from  $R_J$  over  $2^{12}$  rising edges.

**Table 11. Typical Phase Noise Performance**

| Offset Frequency | 25MHz XTAL<br>to 156.25 MHz | 27 MHz Ref In<br>to 148.3517 MHz | 19.44 MHz Ref In<br>to 155.52 MHz | Units  |
|------------------|-----------------------------|----------------------------------|-----------------------------------|--------|
| 100 Hz           | –90                         | –87                              | –110                              | dBc/Hz |
| 1 kHz            | –120                        | –117                             | –116                              | dBc/Hz |
| 10 kHz           | –126                        | –123                             | –123                              | dBc/Hz |
| 100 kHz          | –132                        | –130                             | –128                              | dBc/Hz |
| 1 MHz            | –132                        | –132                             | –128                              | dBc/Hz |
| 10 MHz           | –145                        | –145                             | –145                              | dBc/Hz |

Table 12. Thermal Characteristics

| Parameter                              | Symbol        | Test Condition | Value | Unit |
|--|---------------|----------------|-------|------|
| Thermal Resistance Junction to Ambient | $\theta_{JA}$ | Still Air      | 37    | °C/W |
| Thermal Resistance Junction to Case    | $\theta_{JC}$ | Still Air      | 25    | °C/W |

Table 13. Absolute Maximum Ratings<sup>1</sup>

| Parameter                                      | Symbol    | Test Condition                   | Value            | Unit |
|--|-----------|----------------------------------|------------------|------|
| DC Supply Voltage                              | $V_{DD}$  |                                  | -0.5 to 3.8      | V    |
| Storage Temperature Range                      | $T_{STG}$ |                                  | -55 to 150       | °C   |
| ESD Tolerance                                  |           | HBM<br>(100 pF, 1.5 k $\Omega$ ) | 2.5              | kV   |
| ESD Tolerance                                  |           | CDM                              | 550              | V    |
| ESD Tolerance                                  |           | MM                               | 175              | V    |
| Latch-up Tolerance                             |           |                                  | JESD78 Compliant |      |
| Junction Temperature                           | $T_J$     |                                  | 150              | °C   |
| Peak Soldering Reflow Temperature <sup>2</sup> |           |                                  | 260              | °C   |

**Notes:**

1. Permanent device damage may occur if the Absolute Maximum Ratings are exceeded. Functional operation should be restricted to the conditions as specified in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.
2. Refer to JEDEC J-STD-020 standard for more information.

## 2. Functional Description

### 2.1. Overview



Figure 1. Si5334 Block Diagram

The Si5334 is a high-performance, low-jitter clock generator capable of synthesizing any frequency on each of the device's four differential output clocks. The device accepts an external crystal from 8 to 30 MHz or an input clock ranging from 5 to 710 MHz. Each output is independently factory-programmable to any frequency up to  $F_{vco}/8$  (max of 350 MHz) and select frequencies to 710 MHz.

The Si5334 fractional-N PLL, comprised of a phase detector, charge pump, loop filter, VCO, and dividers, is fully integrated on chip to simplify design. Using Skyworks Solutions' patented MultiSynth technology, each output clock is generated with low jitter and zero ppm frequency error. The device has four MultiSynth output dividers to provide non-integer frequency synthesis on every differential output clock.

The Si5334 output driver is highly flexible. The signal format of each output clock can be user-specified to support LVPECL, LVDS, HCSL, CMOS, HSTL, or SSTL. Each output clock has its own supply voltage to allow for the utmost flexibility in mixed supply operations. The core of the Si5334 has its own supply voltage that can be 1.8, 2.5, or 3.3 V.

The Si5334 supports an optional zero delay mode of operation. In this mode, one of the device output clocks is fed back to the FDBK/FDBKB clock input pins to implement the PLL feedback path and nullify the phase difference between the reference input and the output clocks.

The Si5334D/E/F has a pin-controlled phase increment/decrement feature that allows the user to adjust the phase of each output clock in relation to the other output clocks. The phase of each differential output clock can be set to an accuracy of 20 ps over a range of  $\pm 45$  ns. This feature is available over the 0.16 to  $F_{vco}/8$  MHz frequency range at a maximum rate of phase change of 1.5 MHz.

The Si5334G/H/J has a pin-controlled frequency increment/decrement feature that allows the user to change frequency in steps as small as 1 ppm of the initial frequency to as large as possible as long as the frequency at the output of the MultiSynth stays within the range of 5 MHz to  $F_{vco}/8$  MHz. This feature is available on CLK0A/B only. The frequency step is glitchless. This feature is useful in applications that require a variable clock frequency. It can also be used in frequency margining applications to margin test system clocks during design/verification/test or manufacturing test applications.

For EMI reduction, the Si5334K/L/M supports PCI Express 2.0 compliant spread spectrum on all output clocks that are 100 MHz.

The Si5334 is pin-controlled. No I<sup>2</sup>C interface is provided. The LOLLOS output pin indicates the lock condition of the PLL. An output enable input pin is available on the Si5334A/B/C which affects all the programmed clock outputs. All device specifications are guaranteed across these three core supply voltages. Packaged in a ROHS-6, Pb-free 4x4 mm QFN package, the device supports the industrial temperature range of -40 to +85 °C.

After core power is applied, the Si5334 downloads the factory-programmed NVM into RAM and begins operation.

## 2.2. Crystal/Clock Input

The device can be driven from either a low frequency fundamental mode crystal (8–30 MHz) or an external reference clock (5–710 MHz). The crystal is connected across pins IN1 and IN2.

The PCB traces between the crystal and the device must be kept very short to minimize stray capacitance. To ensure maximum compatibility with crystals from multiple vendors, the internal crystal oscillator provides adaptive crystal drive strength based upon the crystal frequency.

The crystal load capacitors are placed on-chip to reduce external component count. If a crystal with a load capacitance outside the range specified in Tables 2, 3, and 12 is supplied to the device, it will result in a slight ppm error in the device clock output frequencies. This error can be compensated for by a small change in the input to output multiplication ratio.

If a reference clock is used, the device accepts a single-ended input reference on IN3 or a differential LVPECL, LVDS, or HCSL source on IN1 and IN2. The input at IN3 can accept an input frequency up to 200 MHz. The signal applied at IN3 should be dc-coupled because internally this signal is ac-coupled to the receive input. A single-ended reference clock up to 350 MHz can be ac-coupled to IN1. A differential reference clock, such as LVPECL, LVDS or HCSL, is input on IN1,2 for frequencies up to 700 MHz. The differential input to IN1,2 requires 0.1  $\mu$ F ac coupling caps to be located near the device and a 100  $\Omega$  termination resistor to be located between these caps and the transmission line going back to the differential driver. See “AN408: Termination Options for Any-Frequency, Any-Output Clock Generators and Clock Buffers” for more information on connecting input signals to IN1,2,3.

This application note can be downloaded from <https://www.skyworksinc.com/en/Products/Timing>.

## 2.3. Zero Delay Mode

A clock that is input to the Si5334 will have an unspecified amount of delay from the input pins to the output pins. The zero delay mode can be used to reduce the delay through the Si5334 to typically less than 100 ps. This is accomplished by feeding back the CLK3 output to either IN4 or IN5,6. Using CLK3 allows for an easy PCB route of this signal back to the input. The R3 divider must be set to 1 when using feedback from CLK3 to implement the zero delay mode. All output clocks that are required to have zero delay must also have their Rn divider set to 1. A single-ended signal up to 200 MHz from CLK3 can be input to IN4. A single-ended signal up to 350 MHz from CLK3 can be input to IN5 using the technique shown in AN408. A differential signal up to 710 MHz from CLK3a,b must be input to IN5,IN6.

The IN4 input is electrically the same as IN3 described above. The IN5,IN6 inputs are electrically the same as the IN1,IN2 inputs described above. See AN408 for additional information on signal connections for the zero delay mode.

## 2.4. Breakthrough MultiSynth Technology

Next-generation timing IC architectures require a wide range of frequencies which are often non-integer related. Traditional clock architectures address this by using multiple single PLL ICs, often at the expense of BOM complexity and power. The Si5334 and Si5338 use patented MultiSynth technology to dramatically simplify timing architectures by integrating the frequency synthesis capability of 4 Phase-Locked Loops (PLLs) in a single device, greatly minimizing size and power requirements versus traditional solutions.

Based on a fractional-N PLL, the heart of the architecture is a low phase noise, high frequency VCO. The VCO supplies a high frequency output clock to the MultiSynth block on each of the four independent output paths. Each MultiSynth operates as a high speed fractional divider with Skyworks Solutions' proprietary phase error correction to divide down the VCO clock to the required output frequency with very low jitter.

The first stage of the MultiSynth architecture is a fractional-N divider which switches seamlessly between the two closest integer divider values to produce the exact output clock frequency with 0 ppm error. To eliminate phase error generated by this process, MultiSynth calculates the relative phase difference between the clock produced by the fractional-N divider and the desired output clock and dynamically adjusts the phase to match the ideal clock waveform. This novel approach makes it possible to generate any output clock frequency without sacrificing jitter performance.

Based on this architecture, the output of each MultiSynth can produce any frequency from 5 to  $F_{vco}/8$  MHz. To support higher frequency operation, the MultiSynth divider can be bypassed. In bypass mode integer divide ratios of 4 and 6 are supported, which allows for output frequencies of  $F_{vco}/4$  and  $F_{vco}/6$  MHz which translates to 367–473.3 MHz and 550–710 MHz respectively. Because each MultiSynth uses the same VCO output there are output frequency limitations when output frequencies greater than  $F_{vco}/8$  are desired.

For example, if 375 MHz is needed at the output of MultiSynth0, the VCO frequency would need to be 2.25 GHz. Now, all the other MultiSynths can produce any frequency from 5 MHz up to a maximum frequency of  $2250/8 = 281.25$  MHz. MultiSynth1,2,3 could also produce  $F_{vco}/4 = 562.5$  MHz or  $F_{vco}/6 = 375$  MHz. Only two unique frequencies above  $F_{vco}/8$  can be output:  $F_{vco}/6$  and  $F_{vco}/4$ .

## 2.5. Output Driver

There are four clock output channels on the Si5334 (CLK0,CLK1,CLK2,CLK3) with two signal outputs per channel. Each channel may be programmed to be a differential driver or a dual single ended driver. If a channel is factory-programmed to be single ended, then the two outputs for that channel can be factory-programmed to be in-phase or out-of-phase. Si5334 output drivers can be configured as single ended CMOS, SSTL, HSTL or differential LVPECL, LVDS, and HCSL formats.

The supply voltage requirement for each driver format is selectable as shown in Table 14. All unused clock output channels must have their respective VDD0x supply voltage connected to pin 7 and 24 VDD.



Figure 2. Skyworks Solutions' MultiSynth Technology

Table 14. Output Driver Signal Format Selection

| VDD0x Supply Voltage | CMOS | SSTL | HSTL | LVPECL | LVDS | HCSL |
|----------------------|------|------|------|--------|------|------|
| 1.5                  |      |      | X    |        |      |      |
| 1.8                  | X    | X    |      |        | X    | X    |
| 2.5                  | X    | X    |      | X      | X    | X    |
| 3.3                  | X    | X    |      | X      | X    | X    |

An OEB pin is provided to enable/disable the output clocks. When OEB = 0, all outputs that have been factory programmed will be on. When OEB = 1, all clock outputs that have been factory programmed will be off and held to a low level.

## 2.6. Output Clock Initial Phase Offset

Each CLK<sub>n</sub> output of the Si5334 can have its own unique initial phase offset over a range of +/- 45 ns with an accuracy of 20 ps. When the respective R divider is not set to 1, this function is not supported.

## 2.7. Output Clock Phase Increment and Decrement

The Si5334D/E/F has a pin-controlled phase increment/decrement feature that allows the user to adjust the phase of 1 or more output clocks via pin control. Since there is only 1 pin for increment and 1 pin for decrement, each output clock channel needs to be enabled or disabled for this feature. In addition, the magnitude of the phase step must be set for each clock output channel. The phase adjustment accuracy is 20 ps over a range of ±45 ns, and the phase transition is glitchless. This feature is not available on any clock output that has Spread Spectrum enabled. The maximum clock output frequency supported in this mode of operation is  $F_{vco}/8$ , where  $F_{vco}$  is the frequency of the device's internal voltage controlled oscillator for the configured frequency plan. The phase can be changed at a maximum rate of 1.5 MHz. In order to increment or decrement phase it is necessary to input a positive pulse of >100ns followed by a low of >100 ns. Since this feature uses pins 3 and 4, the reference clock must be input at pins 1 and 2 or the crystal used across these pins. Once a Si5334/D/E/F is factory-programmed, the phase increment/decrement parameters cannot be changed. If one desires to subsequently change the phase increment/decrement parameters on a factory-programmed part, the Si5338 clock generator must be used.

If a phase decrement causes a single MultiSynth clock period to be less than  $8/F_{vco}$ , all clock outputs may turn off for up to 10 clock periods and then come back on with the phase setting before the illegal decrement.

## 2.8. Output Clock Frequency Increment and Decrement

The Si5334G/H/J has a pin-controlled frequency increment/decrement feature that allows the user to adjust the frequency at the output of MultiSynth0 only. MultiSynth0 can be connected to any or all of the four output clock buffers with the muxes shown in the "Functional Block Diagram" on page 2. If frequency increment and decrement is required on the other clock outputs the Si5338 should be used. The magnitude of a single frequency step must be factory-programmed. Spread Spectrum and frequency increment/decrement cannot both be active on the same clock output. There is a single pin to control the frequency increment and a single pin to control the frequency decrement. The frequency increment or decrement step size can be factory-programmed from as low as 1 ppm of the initial frequency to a maximum that keeps the output of the MultiSynth within the limits of 5 MHz to  $F_{vco}/8$ . If a frequency increment causes the MultiSynth0 output frequency to go above  $F_{vco}/8$ , then all output clocks may turn off for up to 10 clock cycles and then come back on at the frequency before the increment. If the output frequency needs to go below 5 MHz, refer to "2.9. R Divider Considerations" on page 17 for further information. The frequency transition is glitchless. The frequency can be changed at a maximum rate of 1.5 MHz. In order to increment or decrement frequency it is necessary to input a positive pulse of >100 ns followed by a low of > 100 ns. Since this feature uses pins 3 and 4, the reference clock must be input at pins 1 and 2 or the crystal used across these pins. Once a Si5334/G/H/J is factory-programmed, the frequency increment/decrement parameters cannot be changed. If one desires to subsequently change the frequency increment/decrement parameters on a programmed part, the Si5338 clock generator must be used.

## 2.9. R Divider Considerations

When the requested output frequency of a channel is below 5 MHz, the  $R_n$  ( $n = 0, 1, 2, 3$ ) divider will automatically be set and enabled. When the  $R_n$  divider is active the step size range of the frequency increment and decrement function will decrease by the  $R_n$  divide ratio. The  $R_n$  divider can be set to {1, 2, 4, 8, 16, 32}.

Non-unity settings of  $R_0$  will affect the  $F_{inc}/F_{dec}$  step size at the MultiSynth0 output. For example, if the MultiSynth0 output step size is 2.56 MHz and  $R_0 = 8$ , the step size at the output of  $R_0$  will be 2.56 MHz divided by 8 = .32 MHz. When the  $R_n$  divider is set to non-unity, the initial phase of the CLK<sub>n</sub> output with respect to other CLK<sub>n</sub> outputs is not guaranteed.

## 2.10. Spread Spectrum



**Figure 3. Spread Spectrum Triangle Waveform**

To reduce the electromagnetic interference (EMI), the Si5334K/L/M supports PCI Express compliant spread spectrum on all outputs that are 100 MHz. If CLK0 has spread spectrum enabled, then the Finc/Fdec function is not available on CLK0. Spread spectrum modulation spreads the energy across many frequencies to reduce the EMI across a narrow range of frequencies.

The modulation rate is the time required to transition from the maximum spread spectrum frequency to the minimum spread spectrum frequency and then back to the maximum frequency as shown in Figure 3.

The Si5334K/L/M supports 0.5% downspread at a 30–33 kHz rate with a clock frequency of 100 MHz in compliance with the PCI Express standard. When pin 12 (SSPB) is low the factory-programmed clock outputs will have spread spectrum turned on.

## 2.11. Device Reset

To reset the device, a power cycle must be performed.

## 2.12. LOSLOL Pin

When either a Loss of Lock (LOL) or Loss of Signal (LOS) condition occurs, the LOSLOL pin will assert.

The LOS condition occurs when there is no input clock input to the Si5334. The loss of lock algorithm works by continuously monitoring the frequency difference between the two inputs of the phase frequency detector. When this frequency difference is greater than 1000 ppm, a loss of lock condition is declared. Note that the VCO will track the input clock frequency for up to ~50000 ppm, which will keep the inputs to the phase frequency detector at the same frequency until the PLL comes out of lock. When a clock input is removed, the LOSLOL pin will assert, and the clock outputs may drift up to 5%. When the input clock with an appropriate frequency is re-applied, the PLL will again lock.

## 2.13. Power-Up

Upon powerup, the device performs an internal self-calibration before operation to optimize loop parameters and jitter performance. While the self-calibration is being performed, the device VCO is being internally controlled by the self-calibration state machine and the LOL alarm is masked. The output clocks appear after the device finishes self calibration.

## 2.14. Factory Programming Options

Skyworks Solutions Si5334 clock generators are factory-programmable devices. The functions and frequency plans can be customized to meet the needs of your applications. Contact your local Skyworks Solutions sales representative.

Refer to <https://www.skyworksinc.com/en/application-pages/clockbuilder-pro-software> to access downloadable software to configure the Si5334.

### 3. Pin Descriptions



**Note:** Center pad must be tied to GND for normal operation.

**Table 15. Si5334 Pin Descriptions**

| Pin # | Pin Name | I/O | Signal Type | Description  |
|-------|----------|-----|-------------|--|
| 1,2   | IN1/IN2  | I   | Multi       | <p><b>CLKIN/CLKINB.</b></p> <p>These pins are used as the main differential clock input or as the XTAL input. Clock inputs to these pins must be ac-coupled. A crystal should be directly connected to pins 1,2 with the shortest traces possible. Keep the traces from pins 1,2 to the crystal as short as possible and keep other signals and radiating sources away from the crystal.</p> <p>When not in use, leave IN1 unconnected and IN2 connected to GND.</p> |

Table 15. Si5334 Pin Descriptions (Continued)

| Pin # | Pin Name | I/O | Signal Type | Description   |
|-------|----------|-----|-------------|---|
| 3     | IN3      | I   | Multi       | <p>Keep the input level <math>\geq -0.1</math> V and <math>&lt; V_{DD} + 0.1</math> V.</p> <p><b>REFCLKSE</b><br/>High impedance input for single-ended clock signals such as CMOS. The input should be dc-coupled.</p> <p><b>PINC</b><br/>This pin function is active for devices Si5334D/E/F. A positive pulse of greater than 100 ns width (followed by &gt;100 ns low) will increase the input to output device latency by a factory-programmed amount. The function of this pin is factory programmed.</p> <p><b>FINC</b><br/>This pin function is active for devices Si5334G/H/J. A positive pulse of greater than 100 ns width (followed by &gt;100 ns low) will increase the output frequency of the clock output by a factory-programmed amount. The function of this pin is factory-programmed.</p> <p>If this pin is unused, it should be grounded.</p>  |
| 4     | IN4      | I   | LVC MOS     | <p>Keep the input level <math>\geq -0.1</math> V and <math>&lt; V_{DD} + 0.1</math> V.</p> <p><b>FDBKSE</b><br/>High Impedance input for single-ended clock signals, such as CMOS, when the zero delay mode of operation is required. This input should be dc-coupled.</p> <p><b>PDEC</b><br/>This pin function is active for devices Si5334D/E/F. A positive pulse of greater than 100 ns width (followed by &gt;100 ns low) will decrease the input to output device latency by a factory-programmed amount. The function of this pin is factory-programmed.</p> <p><b>FDEC</b><br/>This pin function is active for devices Si5334G/H/J. A positive pulse of greater than 100 ns width (followed by &gt;100 ns low) will decrease the output frequency of the clock output by a factory-programmed amount. The function of this pin is factory-programmed.</p> <p>If this pin is unused, it should be grounded.</p> |
| 5,6   | IN5/IN6  | I   | Multi       | <p><b>FDBK/FDBKB</b><br/>These pins form a differential input for feedback clock signals when a zero delay mode of operation is in effect. Always AC couple into these pins. When not is use leave FDBK unconnected and connect FDBKB to ground.</p>  |
| 7     | VDD      | VDD | Supply      | <p><b>Core Supply Voltage</b><br/>The device operates from a 1.8, 2.5, or 3.3 V supply. A 0.1 <math>\mu</math>F bypass capacitor should be located very close to this pin.</p>  |

Table 15. Si5334 Pin Descriptions (Continued)

| Pin # | Pin Name | I/O | Signal Type | Description  |
|-------|----------|-----|-------------|--|
| 8     | LOSLOL   | O   | Open Drain  | <b>Loss of Signal or Loss of Lock Indicator.</b><br>0 = No LOS or LOL condition.<br>1 = A LOS or LOL condition has occurred.<br>For this pin a 1–5 k $\Omega$ pull-up resistor to a voltage is required. This voltage may be as high as 3.63 V regardless of the voltage on pin 7. |
| 9     | CLK3B    | O   | Multi       | <b>Output Clock B for Channel 3</b><br>May be a single-ended output or half of a differential output with CLK3A being the other differential half. If unused leave this pin floating.  |
| 10    | CLK3A    | O   | Multi       | <b>Output Clock A for Channel 3</b><br>May be a single-ended output or half of a differential output with CLK3B being the other differential half. If unused leave this pin floating.  |
| 11    | VDDO3    | VDD | Supply      | <b>Output Clock Supply Voltage</b><br>Supply voltage (3.3, 2.5, 1.8, or 1.5 V) for CLK3A,B. A 0.1 $\mu$ F capacitor must be located very close to this pin. If CLK3 is not used, this pin must be tied to VDD (pin 7, 24).   |
| 12    | IN7      | I   | LVC MOS     | <b>SSPB*.</b><br>When low, Spread Spectrum is enabled on every output clock that is programmed for Spread Spectrum. This option is available on the Si5334K/L/M.<br><br>On an Si5334 that does not contain the spread spectrum functionality, this pin should be connected to GND. |
| 13    | CLK2B    | O   | Multi       | <b>Output Clock B for Channel 2</b><br>May be a single-ended output or half of a differential output with CLK2A being the other differential half. If unused leave this pin floating.  |
| 14    | CLK2A    | O   | Multi       | <b>Output Clock A for Channel 2</b><br>May be a single-ended output or half of a differential output with CLK2B being the other differential half. If unused leave this pin floating.  |
| 15    | VDDO2    | VDD | Supply      | <b>Output Clock Supply Voltage.</b><br>Supply voltage (3.3, 2.5, 1.8, or 1.5 V) for CLK2A,B. A 0.1 $\mu$ F capacitor must be located very close to this pin. If CLK2 is not used, this pin must be tied to VDD (pin 7, 24).  |
| 16    | VDDO1    | VDD | Supply      | <b>Output Clock Supply Voltage.</b><br>Supply voltage (3.3, 2.5, 1.8, or 1.5 V) for CLK1A,B. A 0.1 $\mu$ F capacitor must be located very close to this pin. If CLK1 is not used, this pin must be tied to VDD (pin 7, 24).  |

Table 15. Si5334 Pin Descriptions (Continued)

| Pin #   | Pin Name | I/O | Signal Type | Description   |
|---------|----------|-----|-------------|---|
| 17      | CLK1B    | O   | Multi       | <b>Output Clock B for Channel 1</b><br>May be a single-ended output or half of a differential output with CLK1A being the other differential half. If unused, this pin must be tied to VDD pin 24. If unused leave this pin floating.                             |
| 18      | CLK1A    | O   | Multi       | <b>Output Clock A for Channel 1</b><br>May be a single-ended output or half of a differential output with CLK1B being the other differential half. If unused leave this pin floating.   |
| 19      | OEB      | I   | LVC MOS     | <b>Output Enable Low</b><br>When low, all the factory-programmed outputs are enabled. When high all factory programmed outputs are forced to a logic low.   |
| 20      | VDD00    | VDD | Supply      | <b>Output Clock Supply Voltage.</b><br>Supply voltage (3.3, 2.5, 1.8, or 1.5 V) for CLK0A,B. A 0.1 $\mu$ F capacitor must be located very close to this pin. If CLK0 is not used, this pin must be tied to VDD (pin 7, 24).                                       |
| 21      | CLK0B    | O   | Multi       | <b>Output Clock B for Channel 0</b><br>May be a single-ended output or half of a differential output with CLK0A being the other differential half. If unused leave this pin floating.   |
| 22      | CLK0A    | O   | Multi       | <b>Output Clock A for Channel 0</b><br>May be a single-ended output or half of a differential output with CLK0B being the other differential half. If unused leave this pin floating.   |
| 23      | RSVD_GND | GND | GND         | <b>Ground.</b><br>Must be connected to system ground.   |
| 24      | VDD      | VDD | Supply      | <b>Core Supply Voltage.</b><br>The device operates from a 1.8, 2.5, or 3.3 V supply. A 0.1 $\mu$ F bypass capacitor should be located very close to this pin.   |
| GND PAD | GND      | GND | GND         | <b>Ground Pad.</b><br>This is the large pad in the center of the package. Device specifications cannot be guaranteed unless the ground pad is properly connected to a ground plane on the PCB. See section 6.0 for the PCB pad sizes and ground via requirements. |

## 4. Device Pinout by Part Number

The Si5334 is orderable in three different speed grades: Si5334A/D/G/K have a maximum output clock frequency limit of 710 MHz. Si5338B/E/H/L have a maximum output clock frequency of 350 MHz. Si5338C/F/J/M have a maximum output clock frequency of 200 MHz.

Brief pin functions follow.

- **XTAL/CLKIN**—crystal or one side of differential input clock
- **XTAL/CLKINB**—crystal or one side of differential input clock
- **REFCLKSE**—single-ended reference clock input
- **FDBKSE**—single-ended feedback clock input
- **FDBK**—differential feedback input
- **FDBKB**—differential feedback input inverted
- **FINC**—frequency increment pin
- **FDEC**—frequency decrement pin
- **PINC**—phase increment pin
- **PDEC**—phase decrement pin
- **OEB**—output enable low

See the four groupings below for the available pin control functions on pins 3, 4 and 12.



| Pin # | Function    | Pin # | Function |
|-------|-------------|-------|----------|
| 1     | XTAL/CLKIN  | 13    | CLK2B    |
| 2     | XTAL/CLKINB | 14    | CLK2     |
| 3     | REFCLKSE    | 15    | VDDO2    |
| 4     | FDBKSE      | 16    | VDDO1    |
| 5     | FDBK        | 17    | CLK1B    |
| 6     | FDBKB       | 18    | CLK1     |
| 7     | VDD         | 19    | OEB      |
| 8     | INTR        | 20    | VDDO0    |
| 9     | CLK3B       | 21    | CLK0B    |
| 10    | CLK3        | 22    | CLK0     |
| 11    | VDDO3       | 23    | RSVDGND  |
| 12    | GND         | 24    | VDD      |

| Pin # | Function    | Pin # | Function |
|-------|-------------|-------|----------|
| 1     | XTAL/CLKIN  | 13    | CLK2B    |
| 2     | XTAL/CLKINB | 14    | CLK2     |
| 3     | PINC        | 15    | VDDO2    |
| 4     | PDEC        | 16    | VDDO1    |
| 5     | FDBK        | 17    | CLK1B    |
| 6     | FDBKB       | 18    | CLK1     |
| 7     | VDD         | 19    | OEB      |
| 8     | INTR        | 20    | VDDO0    |
| 9     | CLK3B       | 21    | CLK0B    |
| 10    | CLK3        | 22    | CLK0     |
| 11    | VDDO3       | 23    | RSVDGND  |
| 12    | GND         | 24    | VDD      |

# Si5334



| Pin # | Function    | Pin # | Function |
|-------|-------------|-------|----------|
| 1     | XTAL/CLKIN  | 13    | CLK2B    |
| 2     | XTAL/CLKINB | 14    | CLK2     |
| 3     | FINC        | 15    | VDDO2    |
| 4     | FDEC        | 16    | VDDO1    |
| 5     | FDBK        | 17    | CLK1B    |
| 6     | FDBKB       | 18    | CLK1     |
| 7     | VDD         | 19    | OEB      |
| 8     | INTR        | 20    | VDDO0    |
| 9     | CLK3B       | 21    | CLK0B    |
| 10    | CLK3        | 22    | CLK0     |
| 11    | VDDO3       | 23    | RSVDGND  |
| 12    | GND         | 24    | VDD      |

| Pin # | Function    | Pin # | Function |
|-------|-------------|-------|----------|
| 1     | XTAL/CLKIN  | 13    | CLK2B    |
| 2     | XTAL/CLKINB | 14    | CLK2     |
| 3     | REFCLKSE    | 15    | VDDO2    |
| 4     | FDBKSE      | 16    | VDDO1    |
| 5     | FDBK        | 17    | CLK1B    |
| 6     | FDBKB       | 18    | CLK1     |
| 7     | VDD         | 19    | OEB      |
| 8     | INTR        | 20    | VDDO0    |
| 9     | CLK3B       | 21    | CLK0B    |
| 10    | CLK3        | 22    | CLK0     |
| 11    | VDDO3       | 23    | RSVDGND  |
| 12    | SSPB        | 24    | VDD      |

## 5. Ordering Information and Standard Frequency Plans

### 5.1. Ordering Information



### 5.2. Evaluation Boards

Si5338

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EVB

The Si5338 evaluation board allows creation of custom and standard configurations for the Si5334. Refer to <https://www.skyworksinc.com/en/products/timing/evaluation-kits/si5338-evaluation-kit> for more information.

# Si5334

## 5.3. Standard Frequency Plans

**Table 16. Si5334 Standard Frequency Plans**

| Application | OPN               | Input | CLKIN    |              | CLK0     |              | CLK1     |              | CLK2     |              | CLK3     |              |
|-------------|-------------------|-------|----------|--------------|----------|--------------|----------|--------------|----------|--------------|----------|--------------|
|             |                   |       | Freq     | Format       | Freq     | Format       | Freq     | Format       | Freq     | Format       | Freq     | Format       |
| SONET/SDH   | Si5334C-B00099-GM | Clock | 19.4400  | 3.3 V CMOS   | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 77.7600  | 3.3 V LVPECL | 77.7600  | 3.3 V LVPECL |
|             | Si5334C-B00101-GM | Clock | 19.4400  | 3.3 V CMOS   | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL |
|             | Si5334A-B00102-GM | Clock | 19.4400  | 3.3 V CMOS   | 622.0800 | 3.3 V LVPECL | 622.0800 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL |
|             | Si5334C-B00103-GM | Clock | 38.8800  | 3.3 V CMOS   | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 77.7600  | 3.3 V LVPECL | 77.7600  | 3.3 V LVPECL |
|             | Si5334C-B00104-GM | Clock | 38.8800  | 3.3 V CMOS   | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL |
|             | Si5334A-B00105-GM | Clock | 38.8800  | 3.3 V CMOS   | 622.0800 | 3.3 V LVPECL | 622.0800 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL |
|             | Si5334C-B00106-GM | Clock | 155.5200 | 3.3 V LVPECL | 161.1328 | 3.3 V LVPECL | 156.2500 | 3.3 V LVPECL | 156.2500 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL |

Table 16. Si5334 Standard Frequency Plans (Continued)

| Application            | OPN               | Input | CLKIN   |            | CLK0     |              | CLK1     |              | CLK2     |              | CLK3     |            |
|------------------------|-------------------|-------|---------|------------|----------|--------------|----------|--------------|----------|--------------|----------|------------|
|                        |                   |       | Freq    | Format     | Freq     | Format       | Freq     | Format       | Freq     | Format       | Freq     | Format     |
| Ethernet/Fibre Channel | Si5334C-B00107-GM | Xtal  | 25.0000 | n/a        | 161.1328 | 3.3 V LVPECL | 156.2500 | 3.3 V LVPECL | 125.0000 | 3.3 V LVPECL | 25.0000  | 3.3 V CMOS |
|                        | Si5334C-B00108-GM | Clock | 25.0000 | 3.3 V CMOS | 161.1328 | 3.3 V LVPECL | 156.2500 | 3.3 V LVPECL | 125.0000 | 3.3 V LVPECL | 25.0000  | 3.3 V CMOS |
|                        | Si5334B-B00109-GM | Xtal  | 25.0000 | n/a        | 312.5000 | 3.3 V LVPECL | 156.2500 | 3.3 V LVPECL | 125.0000 | 3.3 V LVPECL | 62.5000  | 3.3 V CMOS |
|                        | Si5334B-B00110-GM | Clock | 25.0000 | 3.3 V CMOS | 312.5000 | 3.3 V LVPECL | 156.2500 | 3.3 V LVPECL | 125.0000 | 3.3 V LVPECL | 62.5000  | 3.3 V CMOS |
|                        | Si5334C-B00111-GM | Xtal  | 25.0000 | n/a        | 125.0000 | 3.3 V CMOS   | 125.0000 | 3.3 V CMOS   | 125.0000 | 3.3 V CMOS   | 125.0000 | 3.3 V CMOS |
|                        | Si5334C-B00112-GM | Clock | 25.0000 | 3.3 V CMOS | 125.0000 | 3.3 V CMOS   | 125.0000 | 3.3 V CMOS   | 125.0000 | 3.3 V CMOS   | 125.0000 | 3.3 V CMOS |
|                        | Si5334C-B00113-GM | Xtal  | 25.0000 | n/a        | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS |
|                        | Si5334C-B00114-GM | Clock | 25.0000 | 3.3 V CMOS | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS |
|                        | Si5334C-B00115-GM | Xtal  | 25.0000 | n/a        | 156.2500 | 1.8 V LVDS   | 156.2500 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS |

**Table 16. Si5334 Standard Frequency Plans (Continued)**

| Application                           | OPN               | Input | CLKIN    |              | CLK0     |              | CLK1     |              | CLK2     |              | CLK3     |              |
|---------------------------------------|-------------------|-------|----------|--------------|----------|--------------|----------|--------------|----------|--------------|----------|--------------|
|                                       |                   |       | Freq     | Format       | Freq     | Format       | Freq     | Format       | Freq     | Format       | Freq     | Format       |
| Ethernet/Fibre Channel<br>(Continued) | Si5334C-B00116-GM | Clock | 25.0000  | 3.3 V CMOS   | 156.2500 | 1.8 V LVDS   | 156.2500 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS   |
|                                       | Si5334C-B00117-GM | Xtal  | 25.0000  | n/a          | 125.0000 | 3.3 V CMOS   | 125.0000 | 3.3 V CMOS   | 106.2500 | 3.3 V CMOS   | 106.2500 | 3.3 V CMOS   |
|                                       | Si5334C-B00118-GM | Clock | 25.0000  | 3.3 V CMOS   | 125.0000 | 3.3 V CMOS   | 125.0000 | 3.3 V CMOS   | 106.2500 | 3.3 V CMOS   | 106.2500 | 3.3 V CMOS   |
|                                       | Si5334C-B00119-GM | Xtal  | 25.0000  | n/a          | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS   | 106.2500 | 3.3 V LVPECL | 106.2500 | 3.3 V LVPECL |
|                                       | Si5334C-B00120-GM | Clock | 25.0000  | 3.3 V CMOS   | 125.0000 | 1.8 V LVDS   | 125.0000 | 1.8 V LVDS   | 106.2500 | 3.3 V LVPECL | 106.2500 | 3.3 V LVPECL |
|                                       | Si5334B-B00121-GM | Xtal  | 25.0000  | n/a          | 212.5000 | 3.3 V LVPECL | 212.5000 | 3.3 V LVPECL | 106.2500 | 3.3 V LVPECL | 106.2500 | 3.3 V LVPECL |
|                                       | Si5334B-B00122-GM | Clock | 25.0000  | 3.3 V CMOS   | 212.5000 | 3.3 V LVPECL | 212.5000 | 3.3 V LVPECL | 106.2500 | 3.3 V LVPECL | 106.2500 | 3.3 V LVPECL |
|                                       | Si5334B-B00123-GM | Xtal  | 25.0000  | n/a          | 212.5000 | 3.3 V LVDS   | 212.5000 | 3.3 V LVDS   | 106.2500 | 3.3 V LVDS   | 106.2500 | 3.3 V LVDS   |
|                                       | Si5334B-B00124-GM | Clock | 25.0000  | 3.3 V CMOS   | 212.5000 | 3.3 V LVDS   | 212.5000 | 3.3 V LVDS   | 106.2500 | 3.3 V LVDS   | 106.2500 | 3.3 V LVDS   |
|                                       | Si5334C-B00125-GM | Xtal  | 25.0000  | n/a          | 156.2500 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 125.0000 | 1.8 V LVDS   | 106.2500 | 3.3 V LVPECL |
|                                       | Si5334C-B00126-GM | Clock | 25.0000  | 3.3 V CMOS   | 156.2500 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 125.0000 | 1.8 V LVDS   | 106.2500 | 3.3 V LVPECL |
|                                       | Si5334C-B00127-GM | Clock | 125.0000 | 3.3 V LVPECL | 156.2500 | 3.3 V LVPECL | 156.2500 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL |
|                                       | Si5334C-B00128-GM | Clock | 156.2500 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 155.5200 | 3.3 V LVPECL | 125.0000 | 3.3 V LVPECL | 125.0000 | 3.3 V LVPECL |

Table 16. Si5334 Standard Frequency Plans (Continued)

| Application                    | OPN               | Input | CLKIN    |              | CLK0     |            | CLK1    |            | CLK2    |            | CLK3    |            |
|--------------------------------|-------------------|-------|----------|--------------|----------|------------|---------|------------|---------|------------|---------|------------|
|                                |                   |       | Freq     | Format       | Freq     | Format     | Freq    | Format     | Freq    | Format     | Freq    | Format     |
| Synchronous Ethernet (RX-Side) | Si5334C-B00129-GM | Clock | 19.4400  | 3.3 V CMOS   | 25.0000  | 3.3 V CMOS | 25.0000 | 3.3 V CMOS | 25.0000 | 3.3 V CMOS | 25.0000 | 3.3 V CMOS |
|                                | Si5334C-B00130-GM | Clock | 25.0000  | 3.3 V CMOS   | 19.4400  | 3.3 V CMOS | 19.4400 | 3.3 V CMOS | 19.4400 | 3.3 V CMOS | 19.4400 | 3.3 V CMOS |
|                                | Si5334C-B00131-GM | Clock | 125.0000 | 3.3 V CMOS   | 19.4400  | 3.3 V CMOS | 19.4400 | 3.3 V CMOS | 19.4400 | 3.3 V CMOS | 19.4400 | 3.3 V CMOS |
|                                | Si5334C-B00132-GM | Clock | 156.2500 | 3.3 V LVPECL | 19.4400  | 3.3 V CMOS | 19.4400 | 3.3 V CMOS | 19.4400 | 3.3 V CMOS | 19.4400 | 3.3 V CMOS |
|                                | Si5334C-B00133-GM | Clock | 161.1328 | 3.3 V LVPECL | 19.4400  | 3.3 V CMOS | 19.4400 | 3.3 V CMOS | 19.4400 | 3.3 V CMOS | 19.4400 | 3.3 V CMOS |
| PDH                            | Si5334C-B00134-GM | Clock | 19.4400  | 3.3 V CMOS   | 1.5440   | 3.3 V CMOS | 1.5440  | 3.3 V CMOS | 1.5440  | 3.3 V CMOS | 1.5440  | 3.3 V CMOS |
|                                | Si5334C-B00135-GM | Clock | 19.4400  | 3.3 V CMOS   | 2.0480   | 3.3 V CMOS | 2.0480  | 3.3 V CMOS | 2.0480  | 3.3 V CMOS | 2.0480  | 3.3 V CMOS |
|                                | Si5334C-B00136-GM | Clock | 19.4400  | 3.3 V CMOS   | 2.0480   | 3.3 V CMOS | 2.0480  | 3.3 V CMOS | 1.5440  | 3.3 V CMOS | 1.5440  | 3.3 V CMOS |
|                                | Si5334C-B00137-GM | Clock | 19.4400  | 3.3 V CMOS   | 8.1920   | 3.3 V CMOS | 4.0960  | 3.3 V CMOS | 2.0480  | 3.3 V CMOS | 2.0480  | 3.3 V CMOS |
|                                | Si5334C-B00138-GM | Clock | 19.4400  | 3.3 V CMOS   | 44.7360  | 3.3 V CMOS | 44.7360 | 3.3 V CMOS | 34.3680 | 3.3 V CMOS | 34.3680 | 3.3 V CMOS |
| Broadcast Video                | Si5334C-B00139-GM | Xtal  | 27.0000  | n/a          | 74.2500  | 3.3 V CMOS | 74.1758 | 3.3 V CMOS | 54.0000 | 3.3 V CMOS | 27.0000 | 3.3 V CMOS |
|                                | Si5334C-B00140-GM | Clock | 27.0000  | 3.3 V CMOS   | 74.2500  | 3.3 V CMOS | 74.1758 | 3.3 V CMOS | 54.0000 | 3.3 V CMOS | 27.0000 | 3.3 V CMOS |
|                                | Si5334C-B00141-GM | Xtal  | 27.0000  | n/a          | 74.2500  | 3.3 V CMOS | 74.1758 | 3.3 V CMOS | 74.1758 | 3.3 V CMOS | 27.0000 | 3.3 V CMOS |
|                                | Si5334C-B00142-GM | Clock | 27.0000  | 3.3 V CMOS   | 74.2500  | 3.3 V CMOS | 74.1758 | 3.3 V CMOS | 74.1758 | 3.3 V CMOS | 27.0000 | 3.3 V CMOS |
|                                | Si5334C-B00143-GM | Xtal  | 27.0000  | n/a          | 108.0000 | 3.3 V LVDS | 74.2500 | 3.3 V LVDS | 74.1758 | 3.3 V LVDS | 54.0000 | 3.3 V LVDS |
|                                | Si5334C-B00144-GM | Clock | 27.0000  | 3.3 V CMOS   | 108.0000 | 3.3 V LVDS | 74.2500 | 3.3 V LVDS | 74.1758 | 3.3 V LVDS | 54.0000 | 3.3 V LVDS |

**Table 16. Si5334 Standard Frequency Plans (Continued)**

| Application                        | OPN               | Input | CLKIN   |            | CLK0     |            | CLK1     |            | CLK2     |            | CLK3     |            |
|------------------------------------|-------------------|-------|---------|------------|----------|------------|----------|------------|----------|------------|----------|------------|
|                                    |                   |       | Freq    | Format     | Freq     | Format     | Freq     | Format     | Freq     | Format     | Freq     | Format     |
| <b>Broadcast Video (Continued)</b> | Si5334C-B00145-GM | Xtal  | 27.0000 | n/a        | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS |
|                                    | Si5334C-B00146-GM | Clock | 27.0000 | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS |
|                                    | Si5334C-B00147-GM | Xtal  | 27.0000 | n/a        | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS |
|                                    | Si5334C-B00148-GM | Clock | 27.0000 | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS |
|                                    | Si5334C-B00149-GM | Xtal  | 27.0000 | n/a        | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS |
|                                    | Si5334C-B00150-GM | Clock | 27.0000 | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS |
|                                    | Si5334C-B00151-GM | Xtal  | 27.0000 | n/a        | 148.5000 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 74.2500  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS |
|                                    | Si5334C-B00152-GM | Clock | 27.0000 | 3.3 V CMOS | 148.5000 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 74.2500  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS |
|                                    | Si5334C-B00153-GM | Xtal  | 27.0000 | n/a        | 156.2500 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 108.0000 | 3.3 V LVDS |
|                                    | Si5334B-B00154-GM | Clock | 27.0000 | 3.3 V CMOS | 156.2500 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 108.0000 | 3.3 V LVDS |
|                                    | Si5334C-B00155-GM | Xtal  | 27.0000 | n/a        | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS |
|                                    | Si5334B-B00156-GM | Clock | 27.0000 | 3.3 V CMOS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS |
|                                    | Si5334C-B00157-GM | Xtal  | 27.0000 | n/a        | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS |
|                                    | Si5334C-B00158-GM | Clock | 27.0000 | 3.3 V CMOS | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS |
|                                    | Si5334C-B00159-GM | Xtal  | 27.0000 | n/a        | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS |
|                                    | Si5334C-B00160-GM | Clock | 27.0000 | 3.3 V CMOS | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS |

Table 16. Si5334 Standard Frequency Plans (Continued)

| Application   | OPN               | Input | CLKIN    |            | CLK0     |            | CLK1     |            | CLK2     |            | CLK3     |            |
|---|-------------------|-------|----------|------------|----------|------------|----------|------------|----------|------------|----------|------------|
|   |                   |       | Freq     | Format     | Freq     | Format     | Freq     | Format     | Freq     | Format     | Freq     | Format     |
| <b>Broadcast Video<br/>(Continued)</b>  | Si5334C-B00161-GM | Clock | 74.1758  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS | 74.2500  | 3.3 V CMOS |
|   | Si5334C-B00162-GM | Clock | 74.2500  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS | 74.1758  | 3.3 V CMOS |
|   | Si5334C-B00163-GM | Clock | 148.3516 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS | 148.5000 | 3.3 V LVDS |
|   | Si5334B-B00164-GM | Clock | 148.3516 | 3.3 V LVDS | 270.0000 | 3.3 V LVDS | 270.0000 | 3.3 V LVDS | 270.0000 | 3.3 V LVDS | 270.0000 | 3.3 V LVDS |
|   | Si5334C-B00165-GM | Clock | 148.5000 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS | 148.3516 | 3.3 V LVDS |
|   | Si5334B-B00166-GM | Clock | 148.5000 | 3.3 V LVDS | 270.0000 | 3.3 V LVDS | 270.0000 | 3.3 V LVDS | 270.0000 | 3.3 V LVDS | 270.0000 | 3.3 V LVDS |
| <b>PCIe*</b>  | Si5334M-B00167-GM | Xtal  | 25.0000  | n/a        | 100.0000 | 3.3 V HCSL | 100.0000 | 3.3 V HCSL | 100.0000 | 3.3 V HCSL | 100.0000 | 3.3 V HCSL |
|   | Si5334M-B00168-GM | Clock | 25.0000  | 3.3 V CMOS | 100.0000 | 3.3 V HCSL | 100.0000 | 3.3 V HCSL | 100.0000 | 3.3 V HCSL | 100.0000 | 3.3 V HCSL |
| <b>Notes:</b>   |                   |       |          |            |          |            |          |            |          |            |          |            |
| 1. -0.5% downspread enabled on CLK0-CLK3  |                   |       |          |            |          |            |          |            |          |            |          |            |
| 2. To request new frequency plans/device configurations, please contact your local Skyworks Solutions sales representative. |                   |       |          |            |          |            |          |            |          |            |          |            |

## 6. Package Outline: 24-Lead QFN



**Figure 4. 24-Lead Quad Flat No-lead (QFN)**

**Table 17. Package Dimensions**

| Dimension | Min       | Nom  | Max  |
|-----------|-----------|------|------|
| A         | 0.80      | 0.85 | 0.90 |
| A1        | 0.00      | 0.02 | 0.05 |
| b         | 0.18      | 0.25 | 0.30 |
| D         | 4.00 BSC. |      |      |
| D2        | 2.35      | 2.50 | 2.65 |
| e         | 0.50 BSC. |      |      |
| E         | 4.00 BSC. |      |      |
| E2        | 2.35      | 2.50 | 2.65 |
| L         | 0.30      | 0.40 | 0.50 |
| aaa       | 0.10      |      |      |
| bbb       | 0.10      |      |      |
| ccc       | 0.08      |      |      |
| ddd       | 0.10      |      |      |
| eee       | 0.05      |      |      |

**Notes:**

1. All dimensions shown are in millimeters (mm) unless otherwise noted.
2. Dimensioning and Tolerancing per ANSI Y14.5M-1994.
3. This drawing conforms to the JEDEC Outline MO-220, variation VGGD-8.
4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020C specification for Small Body Components.

## 7. Recommended PCB Land Pattern



**Table 18. PCB Land Pattern**

| Dimension | Min  | Nom  | Max  |
|-----------|------|------|------|
| P1        | 2.50 | 2.55 | 2.60 |
| P2        | 2.50 | 2.55 | 2.60 |
| X1        | 0.20 | 0.25 | 0.30 |
| Y1        | 0.75 | 0.80 | 0.85 |
| C1        |      | 3.90 |      |
| C2        |      | 3.90 |      |
| E         |      | 0.50 |      |

### Notes

#### General:

- All dimensions shown are in millimeters (mm) unless otherwise noted.
- Dimensioning and Tolerancing per ANSI Y14.5M-1994 specification.
- This Land Pattern Design is based on the IPC-7351 guidelines.
- Connect the center ground pad to a ground plane with no less than five vias. These 5 vias should have a length of no more than 20 mils to the ground plane. Via drill size should be no smaller than 10 mils. A longer distance to the ground plane is allowed if more vias are used to keep the inductance from increasing.

#### Solder Mask Design:

- All metal pads are to be non-solder mask defined (NSMD). Clearance between the solder mask and the metal pad is to be 60  $\mu\text{m}$  minimum, all the way around the pad.

#### Stencil Design:

- A stainless steel, laser-cut and electro-polished stencil with trapezoidal walls should be used to assure good solder paste release.
- The stencil thickness should be 0.125 mm (5 mils).
- The ratio of stencil aperture to land pad size should be 1:1 for all perimeter pins.
- A 2x2 array of 1.0 mm square openings on 1.25 mm pitch should be used for the center ground pad.

#### Card Assembly:

- A No-Clean, Type-3 solder paste is recommended.
- The recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.

# Si5334

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## 8. Top Marking

### 8.1. Si5334 Top Marking



### 8.2. Top Marking Explanation

| Line   | Characters                                     | Description  |
|--------|--|--|
| Line 1 | Si5334   | Base part number.  |
| Line 2 | Xxxxxx   | X = Frequency and configuration code. See "5. Ordering Information and Standard Frequency Plans" on page 25 for more information.<br>xxxxx = NVM code.<br>See "5. Ordering Information and Standard Frequency Plans" . |
| Line 3 | RTTTTT   | R = Product revision.<br>TTTTT = Manufacturing trace code.   |
| Line 4 | Circle with 0.5 mm diameter;<br>left-justified | Pin 1 indicator.   |
|        | YYWW   | YY = Year.<br>WW = Work week.<br>Characters correspond to the year and work week of package assembly.  |

## 9. Device Errata

Please visit [www.skyworksinc.com](http://www.skyworksinc.com) to access the device errata document.

## DOCUMENT CHANGE LIST

### Revision 0.1 to Revision 0.15

- Updated tables for ac/dc specs to remove TBDs.
- Updated ordering OPN in Table 10 from 34C to 34M-00167/00168-GM.
- Updated SSC information for correct part number.
- Removed diagram in Section 3.
- Corrected Pin 12 description
- Removed low-power LVPECL mode.
- Updated pin descriptions to say 710 MHz.
- Added PCB layout notes on via requirements for GND pad.
- Removed description of field programming as this is not supported.

### Revision 0.15 to Revision 0.16

- Changed cycle-cycle jitter spec from pk-pk to pk.
- Change refclk1 pin name to refclkse.

### Revision 0.16 to Revision 1.0

- Updated Table 2, “DC Characteristics,” on page 4.
  - Updated dc characteristics for CMOS loads.
  - Added core supply current in buffer mode.
  - Added CML output buffer supply current in CML mode.
- Updated Table 3, “Performance Characteristics,” on page 5.
  - PLL Lock Range test changed to PLL Tracking Range and added typical specification.
  - Added Maximum Propagation Delay value.
- Updated Table 4, “Input and Output Clock Characteristics,” on page 6.
  - Added CML Output specs.
  - Corrected VI to 3.73 V.
  - Corrected tR/tF (15 pF) to 2.0 ns.
  - Corrected LVPECL Output Voltage (typ) to VDDO – 1.45.
- Updated Table 5, “Control Pins,” on page 9.
  - Updated V<sub>IH</sub> to 3.73 V.
  - Corrected V<sub>IL</sub> and V<sub>OL</sub>.
- Expanded Tables 6–9 with recommended and supported crystal load capacitance values.
- Updated Table 10, “Jitter Specifications<sup>1,2,3</sup>,” on page 11.
  - Updated typical specifications for total jitter for PCI Express 1.1 Common clocked topology.
  - Updated typical specifications for RMS jitter for PCI Express 2.1 Common clocked topology.
  - Removed RMS jitter specification for PCI Express 2.1 and 3.0 Data clocked topology.
- Updated Table 12, “Thermal Characteristics,” on page 13.

- Updated Table 13, “Absolute Maximum Ratings<sup>1</sup>,” on page 13
  - Added MSL level information.
  - Added Peak Soldering Reflow Temperature.
- Corrected Table 15, “Si5334 Pin Descriptions,” on page 19.
  - Changed “Supply” to “LVCMOS” for IN7 (pin 12).
- Updated and moved “5. Ordering Information and Standard Frequency Plans” on page 25.
- Added “8. Top Marking” on page 34.
- Added “9. Device Errata” on page 35.

### Revision 1.0 to Revision 1.1

- Removed down spread errata that has been corrected in revision B.
- Updated ordering information to refer to Revision B silicon.
- Updated top marking explanation in section 8.2.
- Updated “Device Pinout by Part Number” part number references.
- Standard frequency plan OPNs in Table 16 updated to reflect Rev B part numbers.

### Revision 1.1 to Revision 1.2

- Added link to errata document.

### Revision 1.2 to Revision 1.3

- Removed MSL rating.



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